

**PRODUCT  
DATASHEET**

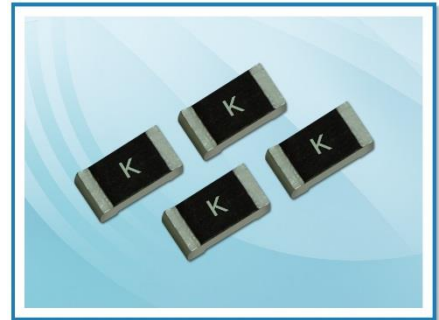


**SMFF1206 Series Surface Mount Fuses Devices**

## SMFF1206 Series Surface Mount Fuses Devices

### Description

Polytronics SMFF1206 series surface mount fast-acting fuse utilizes thick film process with extremely stable fusing element. The glass over coating can tolerate higher temperature profile, and the non-flammable ceramic substrate offers better heat conductivity and safety. SMFF1206 series is also RoHS compliant and halogen-free to meet global environmental standard.






### Features

- Fast acting
- Compact size
- Thick film manufacturing method
- Ceramic substrate with silver fusing element
- Excellent environmental integrity


### Application

- Battery packs
- Digital camera
- Game equipment
- Wireless base station
- Portable device battery chargers (Mobile phone, PDA battery charger, etc.)
- LCD monitors and modules
- PC related equipment / peripherals

### Agency Approval and Environmental Compliance

Agency	File Number	Regulation	Standard
	UL/CSA:E331807		2011/65/EU
			IEC 61249-2-21:2003

### Electrical Characteristics

Part Number	Marking	Current Rating (A)	Voltage Rating	Interrupting Rating	Max Cold DCR <sup>†</sup> (Ω)	Typical I <sup>2</sup> T <sup>‡</sup> (A <sup>2</sup> S)	Agency Approval
							
SMFF1206P150	K	1.50	32V DC	50A / 32V DC	0.1300	0.0491	✓
SMFF1206P200	N	2.00			0.0740	0.1251	✓
SMFF1206P250	O	2.50			0.0510	0.1255	✓
SMFF1206P300	P	3.00			0.0330	0.1350	✓
SMFF1206P350	R	3.50			0.0325	0.1948	✓
SMFF1206P400	S	4.00	32V DC	35A / 32V DC	0.0210	0.3025	✓
SMFF1206P500	T	5.00			0.0165	0.5207	✓
SMFF1206P600	6	6.00			0.0145	0.8134	✓
SMFF1206P700	U	7.00			0.0085	4.0418	✓

<sup>†</sup> Measured at ≤10% rated current and 25°C

<sup>‡</sup> Melting I<sup>2</sup>T at 10 times of rated current

## SMFF1206 Series Surface Mount Fuses Devices

### Electrical Specification

Ampere Rating	% of Current Rating	Opening Time
1.5A~7A	100%	4 Hours Min.
	250%	5 Seconds Max.

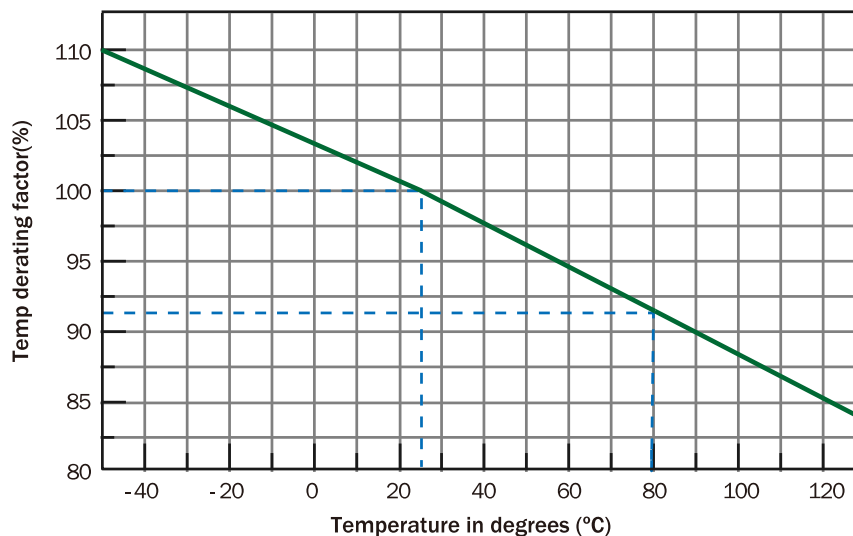
### Physical Specifications

<b>Materials</b>	Substrate: Ceramic Terminations: Silver over-plated with 100% tin Element: Silver or Silver/palladium
<b>Solderability</b>	MIL-STD-202
<b>Soldering Parameters</b>	Wave Solder: 260°C, 10 seconds max. Reflow Solder: 260°C, 5 seconds max. Hand Solder: 350°C, 5 seconds max.

### Environmental Specifications

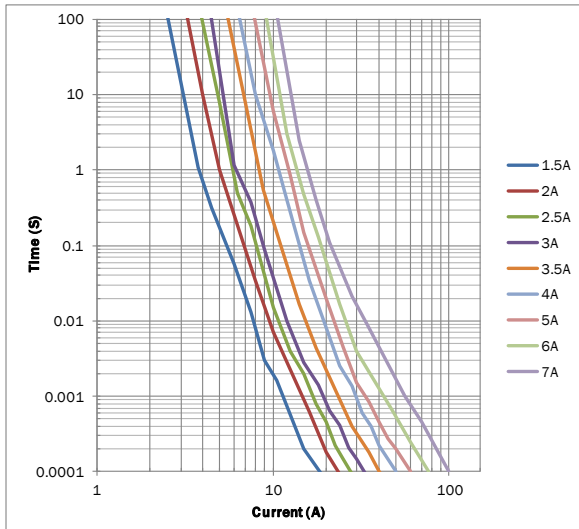
<b>Operating Temperature</b>	-50°C to 125 °C
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### Thermal Derating Curve

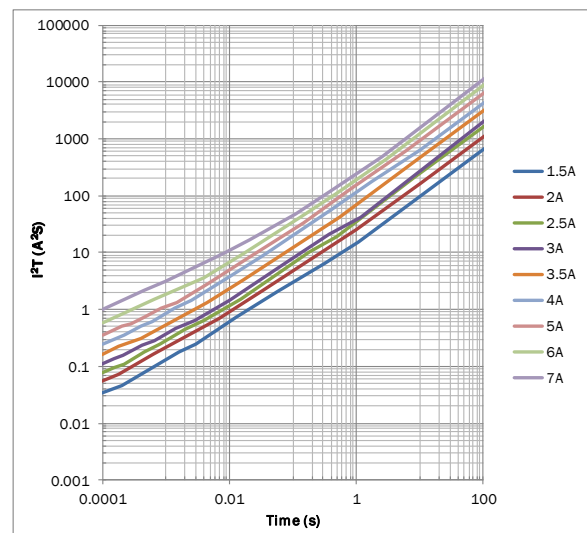


## SMFF1206 Series Surface Mount Fuses Devices

**Time-Current Curve**



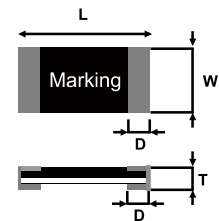
**I<sup>2</sup>T vs Time Curve**



### Physical Dimensions (mm.)

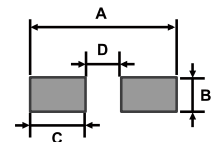
Dimensions (mm)

L	W	T	D
3.10±0.20	1.55±0.20	0.55±0.20	0.50±0.20



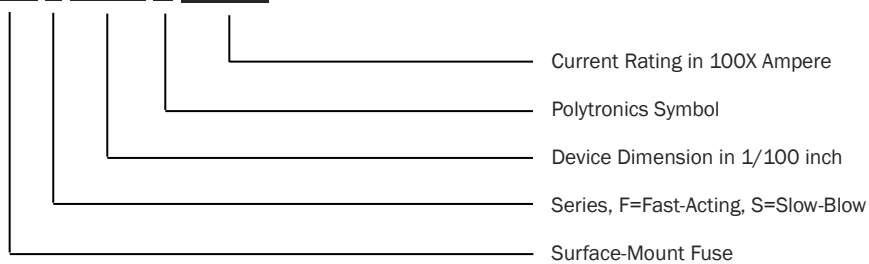
Recommended Solder Pad Dimension (mm)

A	B	C	D
4.4±0.5	2.4±0.3	1.2±0.3	2.0±0.3



### Part Number

**SMF F 1206 P** □□□



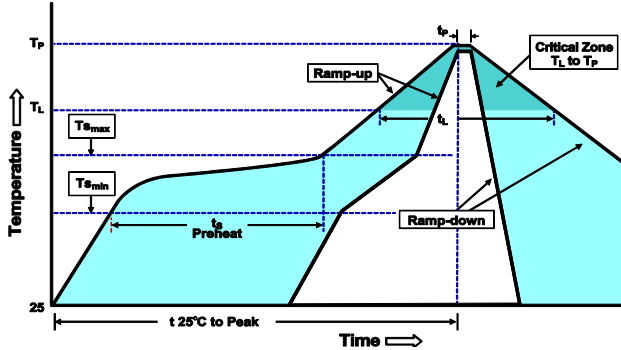
## SMFF1206 Series Surface Mount Fuses Devices

### Reliability Test

Characteristics	Test condition / Methods	Requirement	Test Reference
Voltage Drop	100% In; Temperature in fuse was stabilized	Deviation between the mean value: <15%	IEC 60127-1
Time/Current	100% In	No fusing, 4 hours min.	Refer to Spec.
	250% In	Within 5 seconds	
Endurance Test	100% In; 1hour on, 15min off, 100cycles; then 1hour at 125% In	ΔR  : <10% Legible appearance	IEC 60127-1
Maximum Sustained Dissipation	125% In, during the last 10 minutes of the Endurance Test	Changed with current rating	IEC 60127-1
Temperature Rise	100% In	ΔT  <75°C	UL 248-14
Interrupting Ability	50A / 32V DC (1.5mA~3.5A) 32A / 32V DC (4A~7A)	No permanent arcing, ignition, and bursting of fuse link	UL 248-14
Solderability	240°C ± 5°C, 3sec ± 0.5sec	95% coverage min	IEC 60127-4 IEC 60068-2-20 MIL-STD-202
Resistance to Soldering	260°C ± 5°C, 10sec ± 0.5sec	ΔR  : <10% Legible appearance	MIL-STD-202 IEC 60127-4
Bending Test	Distance between holding points: 90mm Bending: 1 mm; Time, 10 seconds	ΔR  : <10% No mechanical damages	IEC 60127-4
High Temperature Operating Life	70°C ± 2°C at 60% In, 96 hours ;	ΔR  : <10%; no fusing	MIL-STD-202 Method 108
Low Temperature Storage	-55°C ± 2°C, 96 hours	ΔR  : <10%	IEC 60068-2-1
High temperature Storage	125°C ± 2°C, 96 hours	ΔR  : <10%	IEC 60068-2-2
Humidity (Steady State)	40°C ± 2°C, 90~95%RH for 1000 hours	ΔR  : <10%	MIL-STD-202 Method 103
Salt Spray	5% salt solution, 48 hours exposure	ΔR  : <10% Legible appearance	MIL-STD-202 Method 101
Thermal Shock	5 cycles between -55°C /+125°C 60 minutes at each extreme zone	ΔR  : <10% No mechanical damage	IEC 60068-2-14

## SMFF1206 Series Surface Mount Fuses Devices

### Soldering Parameters

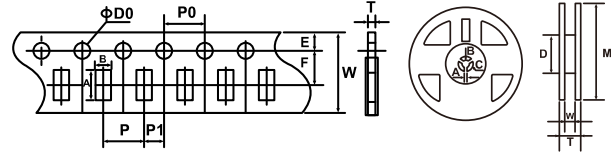


Average Ramp-Up Rate (T <sub>lmax</sub> to T <sub>P</sub> )	3°C/second max.
Preheat	
-Temperature Min (T <sub>lmin</sub> )	150°C
-Temperature Max (T <sub>lmax</sub> )	200°C
-Time (T <sub>lmin</sub> to T <sub>lmax</sub> )	60-120 seconds
Time maintained above:	
-Temperature (T <sub>l</sub> )	217°C
-Time (t <sub>L</sub> )	20-30 seconds
Peak Temperature (T <sub>P</sub> )	260°C
Time within 5°C of actual Peak Temperature (t <sub>P</sub> )	5 seconds
Ramp-Down Rate	6°C /second max.
Time 25°C to Peak Temperature	8 minutes max.

Note 1: All temperature refer to topside of the package, measured on the package body surface.

Note 2: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

### Tape & Reel Specification (mm.)



A	3.50 ± 0.20
B	1.90 ± 0.20
W	8.00 ± 0.20
F	3.50 ± 0.05
E	1.75 ± 0.10
P	4.00 ± 0.10
P0	4.00 ± 0.10
P1	2.00 ± 0.05
D0	Ø 1.50 ± 0.10
T	0.75 ± 0.10

M	Ø178.0 ± 2.0
W	9.5 ± 1.0
T	12.5 ± 1.5
A	2.0 ± 0.5
B	Ø 13.0 ± 0.5
C	Ø 21.0 ± 0.5
D	Ø 58.0 ± 2.0

### Packaging Quantity

Part Number	Tape & Reel Quantity
SMFF1206PXXX	5000